

09/970,100

Certificate

JAN 3 1 2007

## of Correction

PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

ay 12,2001

Jennifer A. Steel

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Vishnu K. Agarwal and Scott G.

Attorney Docket No.: 500453.04

Meikle

Patent No. : US 6,890,591 B2

Issued

: May 10, 2005

Title

: POLISHING PADS AND PLANARIZING MACHINES FOR MECHANICAL OR CHEMICAL-MECHANICAL PLANARIZATION OF MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES, AND METHODS FOR MAKING AND USING SUCH

PADS AND MACHINES

## **NOTIFICATION OF ERRORS**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The following errors were noted in a review of the above-identified letters patent. One of these errors was inadvertently made in the original application, while the others occurred in the printing of the patent. Since the errors are of an obvious nature, a formal Certificate of Correction is not believed to be warranted at this time. Therefore, applicants request that this notification be placed in the Patent and Trademark Office file.

Column, Line

Reads

Should Read

Item (56),

"Chemcial Vapor Deposition"

-- Chemical Vapor Deposition--

References Cited,

Other Publications,

Pierson Reference

Column 2, Line 8 "C—C the substrate" --C—C of the substrate--

Column 6, Line 12 "member 150; in which case" --member 150, in which case-

Column 6, Line 32 "polishing pad, die IC-1000" --polishing pad, the IC-1000--

Column 8, Line 42 "backing member 150" --backing member 150,--

Column 8, Line 53 "is then formed –over" --is then formed over--

Column 10, Line 23 "webformat pad," --web-format pad,--

Column 10, Line 63 "polymeric material," --polymeric material;--

Column 10, Line 66 "surface of e intermediate" --surface of the intermediate--

Respectfully submitted,

Edward W. Bulchis, Reg. No. 26,847

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Enclosure:

Postcard

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